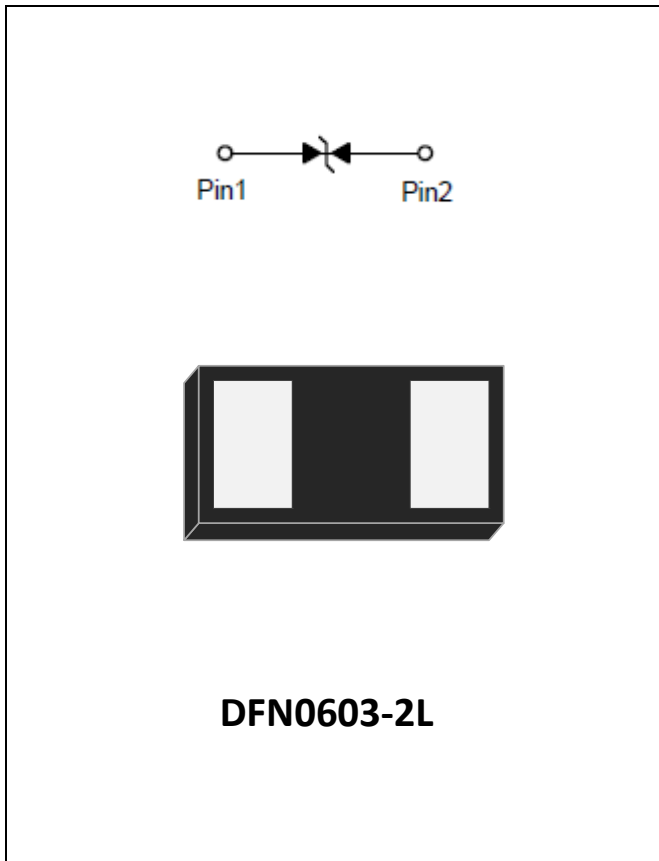


1- Line, Bi-directional, Transient Voltage Suppressor



Features

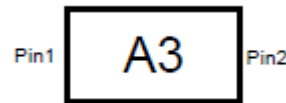
- Ultra small package
- Stand-off voltage: 3.3V Max
- Transient protection for each line according to
IEC61000-4-2(ESD): 12kV (contact)
IEC61000-4-5(surge): 4A (8/20 μ s)
- Low leakage current
- Low clamping voltage
- RoHS Compliant

Applications

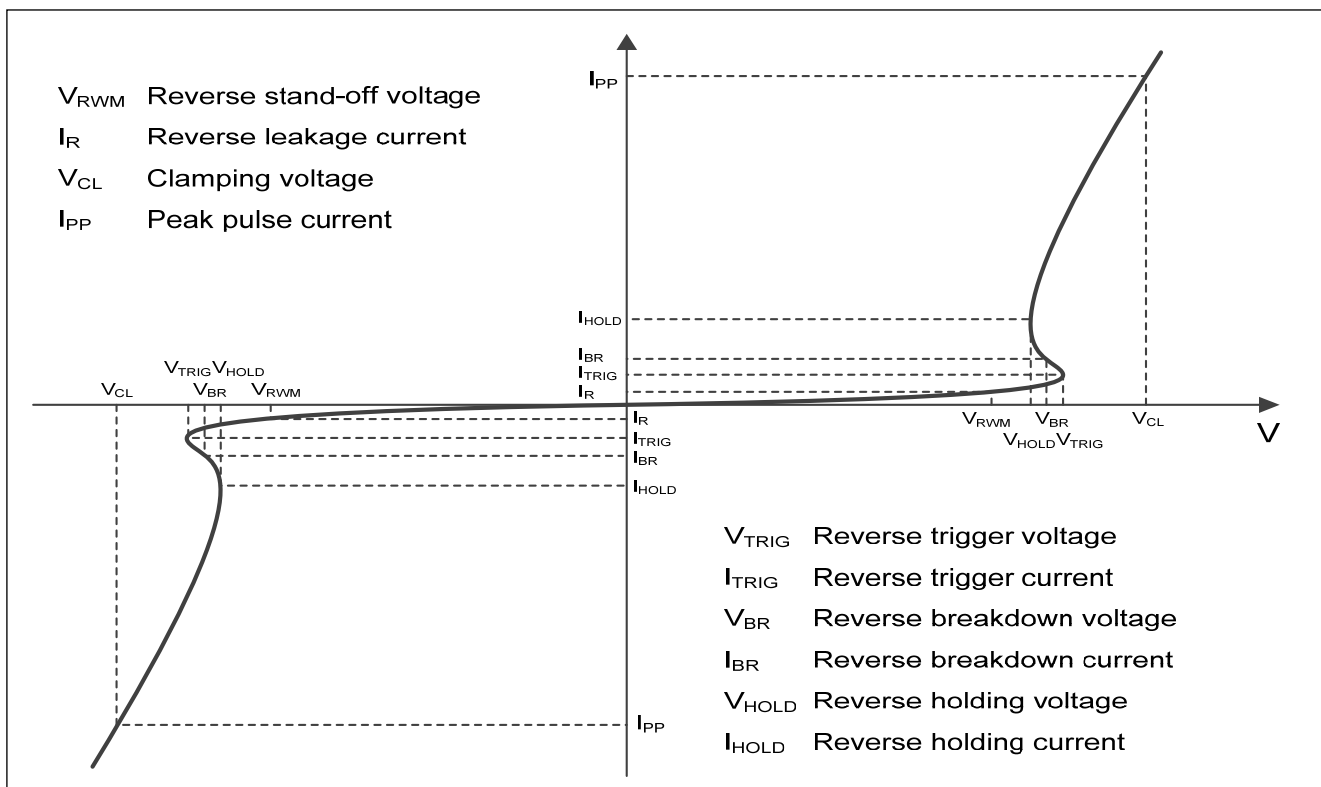
- Cellular handsets
- Tablets
- Laptops
- Other portable devices
- Network communication devices

Mechanical Characteristics

- Package: DFN0603-2L
- Case Material: "Green" Molding Compound.
- Marking Information: See Below



■ Definitions of electrical characteristics





SESDULC3V3LZBS

■Absolute Maximum Ratings (Ta=25°C unless otherwise specified)

PARAMETER	SYMBOL	Rating	UNIT
Peak pulse power ($t_p = 8/20\mu s$)	P_{pk}	13	W
Peak pulse current ($t_p = 8/20\mu s$)	I_{PP}	4	A
ESD according to IEC61000-4-2 air discharge	V_{ESD}	± 15	KV
ESD according to IEC61000-4-2 contact discharge		± 12	KV
Junction temperature	T_J	-55~125	°C
Storage temperature	T_{STG}	-55~150	°C

■Electrical Characteristics (Ta=25°C Unless otherwise specified)

PARAMETER	Symbol	UNIT	Conditions	Min	Typ	Max
Reverse maximum working voltage	V_{RWM}	V				3.3
Reverse breakdown voltage	V_{BR}	V	$I_{BR} = 1mA$	4.5		8
Reverse leakage current	I_R	μA	$V_{RWM} = 3.3V$			0.1
Clamping voltage ³⁾	V_{CL}	V	$I_{PP} = 1A, t_p = 8/20\mu s$		1.75	
		V	$I_{PP} = 4A, t_p = 8/20\mu s$		2.9	
Junction capacitance	C_J	pF	$V_R = 1V, f = 1MHz$		0.2	

(1). TLP parameter: $Z_0 = 50\Omega$, $t_p = 100ns$, $t_r = 2ns$, averaging window from 60ns to 80ns. R_{DYN} is calculated from 4A to 16A.

(2). Contact discharge mode, according to IEC61000-4-2.

(3). Non-repetitive current pulse, according to IEC61000-4-5.

■Ordering Information (Example)

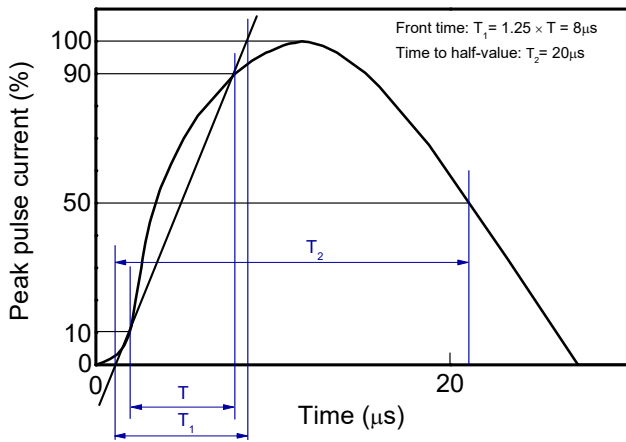
PREFERRED P/N	UNIT WEIGHT(mg)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
SESDULC3V3LZBS	Approximate 0.18	10000	100000	400000	Tae& reel



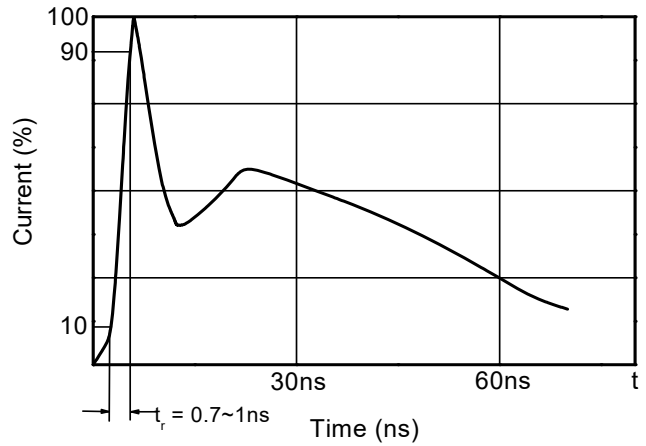
SESDULC3V3LZBS

■ Typical Performance Characteristics (Ta=25°C unless otherwise Specified)

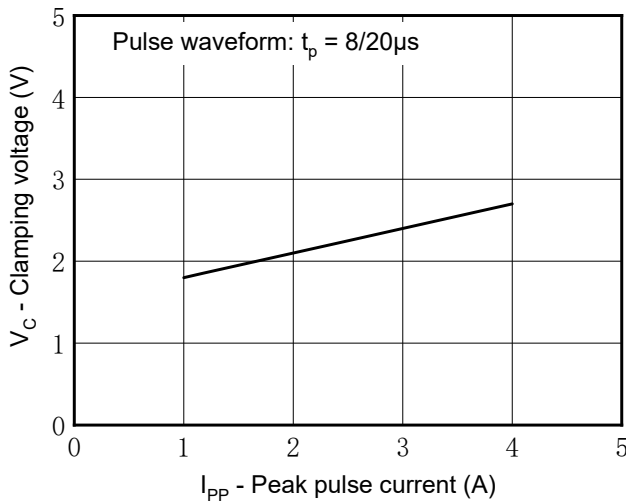
8/20μs waveform per IEC61000-4-5



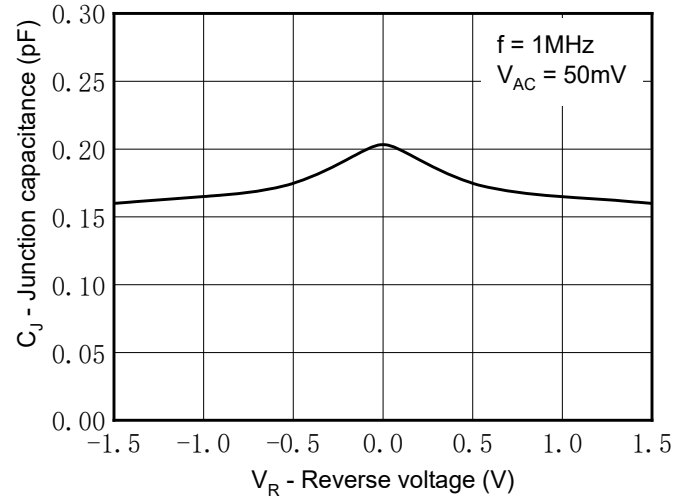
Contact discharge current waveform per IEC61000-4-2



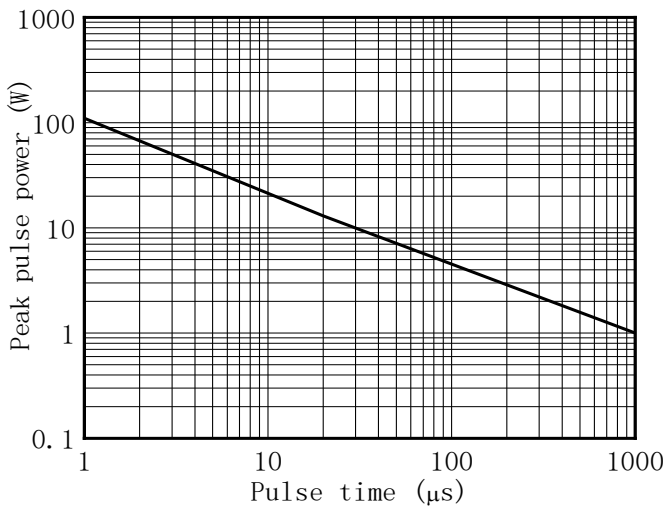
Clamping voltage vs. Peak pulse current



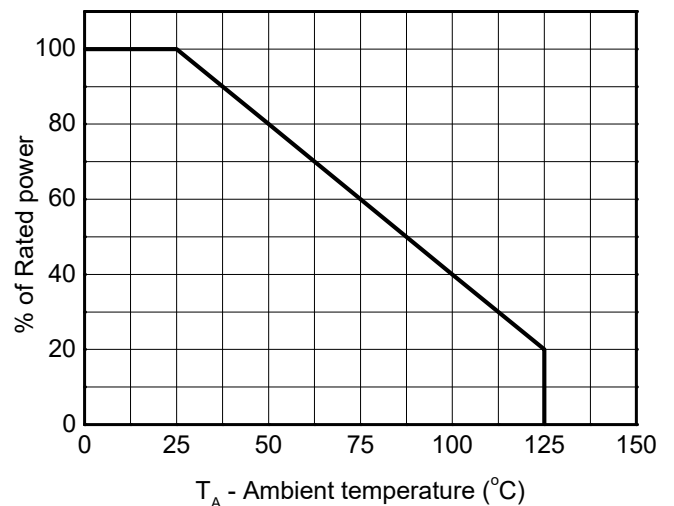
Capacitance vs. Reverse voltage



Non-repetitive peak pulse power vs. Pulse time



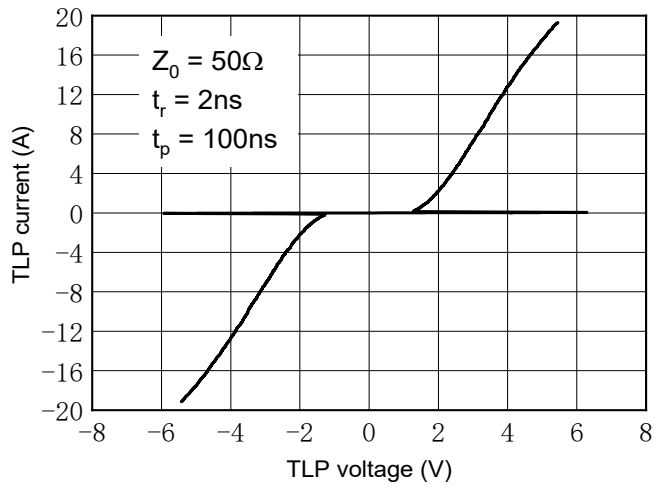
Power derating vs. Ambient temperature



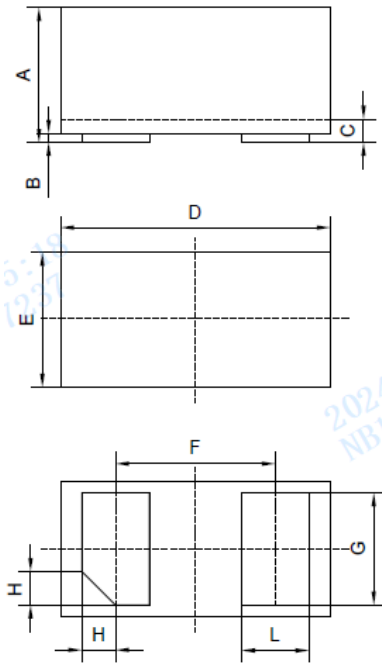


SESDULC3V3LZBS

TLP Measurement

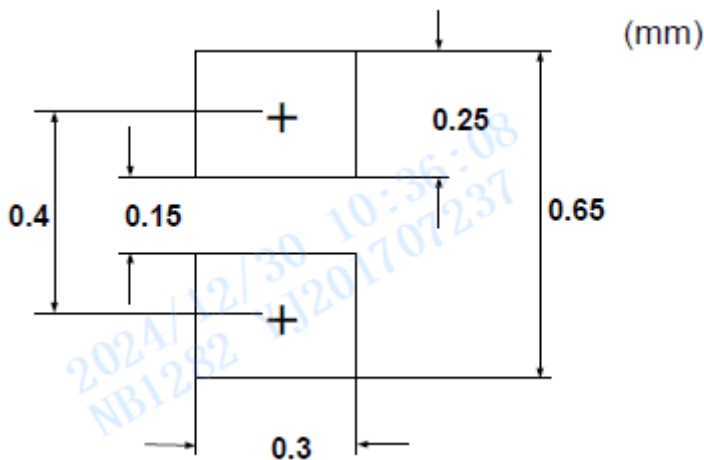


■ Outline Dimensions



DIMENSIONS					
DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	
A	0.008	0.013	0.21	0.33	
B	0.000	0.002	0.00	0.05	
C	0.005	0.007	0.12	0.18	
D	0.022	0.026	0.55	0.65	
E	0.010	0.014	0.25	0.35	
F	0.014		0.355		TYP.
G	0.008	0.011	0.215	0.28	
H	0.003		0.079		TYP.
L	0.006	0.009	0.16	0.22	

■ Recommend land pattern (Unit:mm)



Notes:

This recommended land pattern is for reference purposes only. Please consult your manufacturing group to ensure your PCB design guidelines are met



SESDULC3V3LZBS

Disclaimer

The information presented in this document is for reference only. Yangzhou Yangjie Electronic Technology Co., Ltd. reserves the right to make changes without notice for the specification of the products displayed herein to improve reliability, function or design or otherwise.

The product listed herein is designed to be used with ordinary electronic equipment or devices, and not designed to be used with equipment or devices which require high level of reliability and the malfunction of which would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), Yangjie or anyone on its behalf, assumes no responsibility or liability for any damages resulting from such improper use of sale.

This publication supersedes & replaces all information previously supplied. For additional information, please visit our website [http:// www.21yangjie.com](http://www.21yangjie.com) , or consult your nearest Yangjie's sales office for further assistance.